1241050-2 - ACTIVE

AMPMODU | AMPMODU Headers

TE Internal #: 1241050-2 PCB Mount Header, Vertical, Board-to-Board, 4 Position, 2.54 mm [. 1 in] Centerline, Breakaway, Gold, Surface Mount, Signal, Black, AMPMODU Headers

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PCB Connector Assembly Type: PCB Mount Header

PCB Mount Orientation: Vertical

Connector System: Board-to-Board

Number of Positions: 4

Number of Rows: 2

Features

Product Type Features

PCB Connector Assembly Type

Connector System

Header Type

PCB Mount Header

Board-to-Board

Breakaway



Sealable	No
Connector & Contact Terminates To	Printed Circuit Board
Configuration Features	
Connector Contact Load Condition	Fully Loaded
PCB Mount Orientation	Vertical
Number of Positions	4
Number of Rows	2
Board-to-Board Configuration	Parallel
Body Features	
Primary Product Color	Black
Contact Features	
Mating Square Post Dimension	.64 mm[.025 in]
PCB Contact Termination Area Plating Material Thickness	3 µm
Contact Shape & Form	Square
Contact Underplating Material	Nickel

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PCB Contact Termination Area Plating MaterialTinContact Base MaterialCopper Zinc, Phosphor BronzeContact Mating Area Plating MaterialGoldContact Mating Area Plating Material Thickness.8 µm[31.5 µin]Contact TypePinContact Current Rating (Max)5 ASquare Termination Peatures.64 mm[.025 in]Square Termination Post & Tail Dimension.64 mm[.025 in]Termination Method to Printed Circuit BoardSurface MountMating AlignmentWithoutPCB Mount RetentionWithoutPCB Mount AlignmentWithoutConnector Mounting TypeBoard Mount
Contact Mating Area Plating MaterialGoldContact Mating Area Plating Material Thickness.8 μm[31.5 μin]Contact TypePinContact TypeSAContact Current Rating (Max)5 ATermination FeaturesSquare Termination Post & Tail Dimension.64 mm[.025 in]Termination Method to Printed Circuit BoardSurface MountMating AlignmentWithoutPCB Mount RetentionWithoutPCB Mount AlignmentWithout
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Contact TypePinContact Current Rating (Max)5 ATermination FeaturesSquare Termination Post & Tail Dimension.64 mm[.025 in]Termination Method to Printed Circuit BoardSurface MountMechanical AttachmentMating AlignmentWithoutPCB Mount RetentionWithoutPCB Mount AlignmentWithout
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PCB Mount Retention Without PCB Mount Alignment Without
PCB Mount Alignment Without
Connector Mounting Type Board Mount
Housing Features
Centerline (Pitch) 2.54 mm[.1 in]
Housing Material PCT GF

Dimensions

Row-to-Row Spacing	2.54 mm[.1 in]
PCB Thickness (Recommended)	1.6 mm[.063 in]
Usage Conditions	
Housing Temperature Rating	Standard
Operating Temperature Range	-65 – 105 °C[-85 – 221 °F]
Operation/Application	
Circuit Application	Signal
Industry Standards	
UL Flammability Rating	UL 94V-0
Packaging Features	
Packaging Quantity	350
Packaging Type	Reel

Product Compliance

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For compliance documentation, visit the product page on TE.com>

EU RoHS Directive 2011/65/EU	Compliant
EU ELV Directive 2000/53/EC	Compliant
China RoHS 2 Directive MIIT Order No 32, 2016	No Restricted Materials Above Threshold
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JUNE 2023 (235) Candidate List Declared Against: JUNE 2023 (235) Does not contain REACH SVHC
Halogen Content	Not Low Halogen - contains Br or Cl > 900 ppm.
Solder Process Capability	Reflow solder capable to 260°C

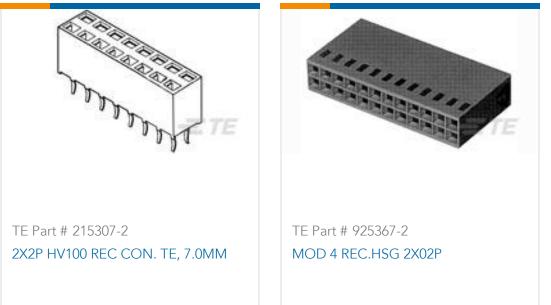
Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-



Compatible Parts





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Also in the Series AMPMODU Headers





PCB Connector Mounting(1)



PCB Headers & Receptacles(4871)

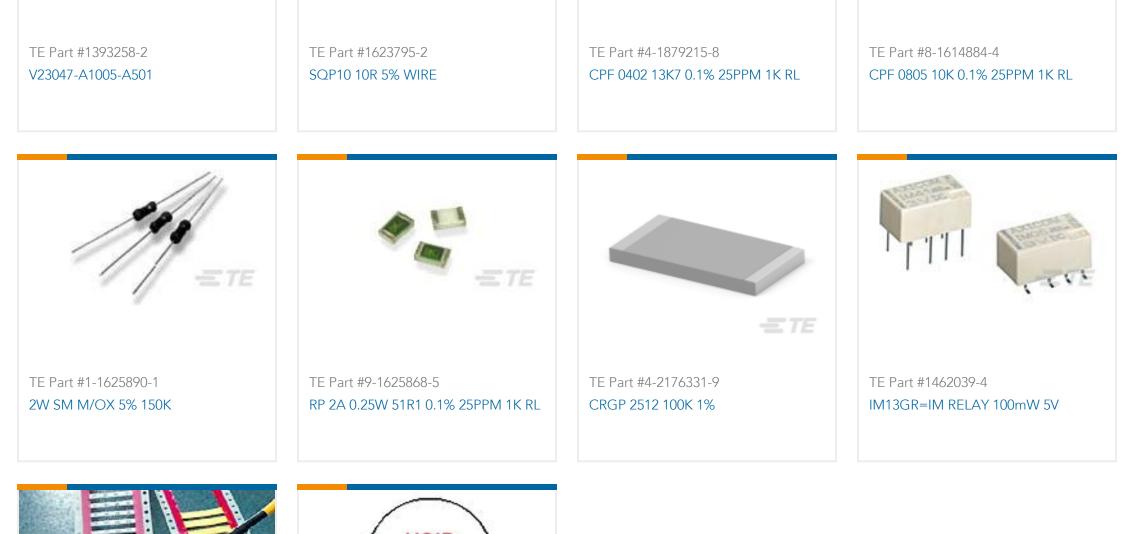


PCB Latches, Locks & Retainers(1)

	And And And
Wire-to-Board Connector Assemblies & Housings(5)	Wire-to-Board Connector Contacts(65)

Customers Also Bought







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Documents

Product Drawings 2x2P MOD II BREAK AWAY HDR,SMD, BLISTER

English

CAD Files

3D PDF

3D

Customer View Model

ENG_CVM_CVM_1241050-2_B.2d_dxf.zip

English

Customer View Model

ENG_CVM_CVM_1241050-2_B.3d_igs.zip

English

Customer View Model

ENG_CVM_CVM_1241050-2_B.3d_stp.zip

English

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Product Environmental Compliance MD_1241050-2_07142016955_dmtec

English

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English